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PRODUCT SUMMARY

**Vishay Siliconix** 

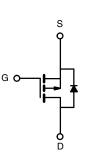


P-Channel 60 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- 100 % UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

Load switch



P-Channel MOSFET

V <sub>DS</sub> (V)	-60
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.0195
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.0250
Q <sub>g</sub> typ. (nC)	76
I <sub>D</sub> (A) <sup>a</sup>	-53
Configuration	Single
Comgulation	Single

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SUP53P06-20-E3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-60	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		-53 <sup>a</sup>		
Continuous durin surrent (T 150 °C)	T <sub>C</sub> = 70 °C		-46.8	A	
Continuous drain current ( $T_J = 150 \ ^{\circ}C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9.2 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		-8.1 <sup>b</sup>		
Pulsed drain current		I <sub>DM</sub>	-150		
Avalanche current pulse		I <sub>AS</sub>	-45		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	101	mJ	
	T <sub>C</sub> = 25 °C		69 <sup>a</sup>		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.1 <sup>b</sup>	— A	
	T <sub>C</sub> = 25 °C		104.2 <sup>a</sup>	w	
Maximum power dissipation	T <sub>C</sub> = 70 °C		66.7 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.1 <sup>b</sup>		
	T <sub>A</sub> = 70 °C		2 <sup>b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	Steady state	R <sub>thJA</sub>	33	40	°C/W
Maximum junction-to-case	Steady state	R <sub>thJC</sub>	0.98	1.2	0/10

Notes

a. Based on T<sub>C</sub> = 25 °C

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SUP53P06-20

**Vishay Siliconix** 

#### b. Surface mounted on 1" x 1" FR4 board

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	-60	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	1 250 4	-	68	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μΑ	-	-5.2	-	- mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1	-	-3	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zana ante colta da alvaira accurat		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
Zero gate voltage drain current	IDSS	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	-120	-	-	А	
	D	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -30 \text{ A}$	-	0.0160	0.0195	0	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -20 \text{ A}$	-	0.0200	0.0250	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -50 A	20	-	-	S	
Dynamic <sup>b</sup>							
Input capacitance	Ciss		-	3500	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	390	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	290	-		
Table also also a		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -55 \text{ A}$	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -55 A - 76		115		
Total gate charge	Qg		-	38	60	nC	
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -30 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -55 A	-	16	-		
Gate-drain charge	Q <sub>gd</sub>		-	19	-		
Gate resistance	R <sub>q</sub>	f = 1 MHz	-	5.2	-	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	15		
Rise time	tr	$V_{DD} = -2 V, R_I = 2 \Omega$	-	7	15	- ns	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -10 \text{ Å}, V_{GEN} = -10 \text{ V}, \text{ R}_g = 1 \Omega$	-	70	110		
Fall time	t <sub>f</sub>		-	40	60		
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-69	A	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	-150		
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -30 A	-	-1	-1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	45	68	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	59	120	nC	
Reverse recovery fall time	ta	$I_F$ = -50 A, di/dt = 100 A/µs, T <sub>J</sub> = 25 °C	-	29	-		
Reverse recovery rise time	t <sub>b</sub>		-	16	_	ns	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

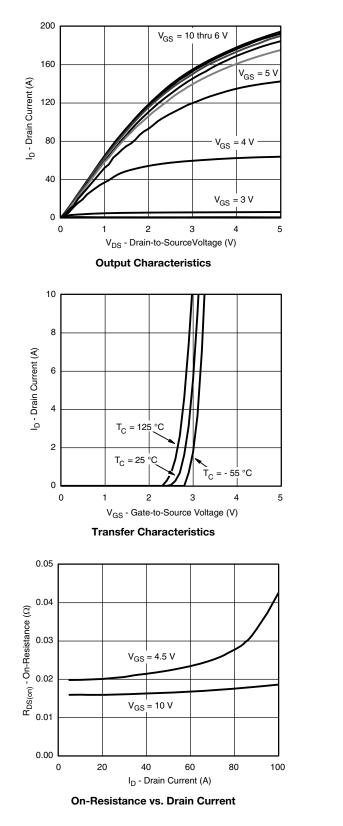
b. Guaranteed by design, not subject to production testing

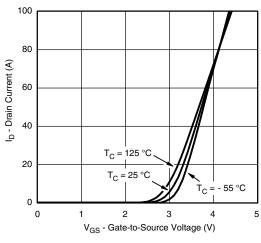
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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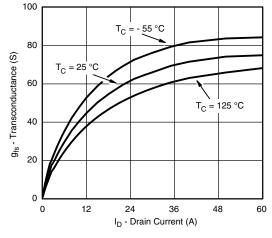


### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

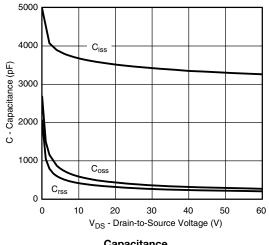




**Transfer Characteristics** 







Capacitance

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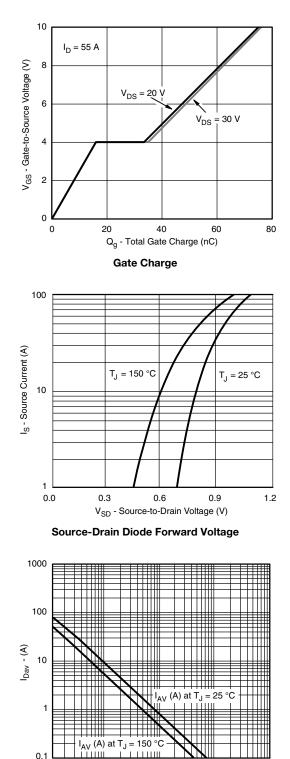
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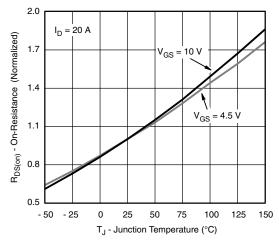


 $\label{eq:Tin-(s)} T_{\text{in}} \, \cdot \, (s)$  Single Pulse Avalanche Current Capability vs. Time

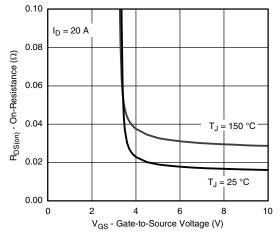
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0.1

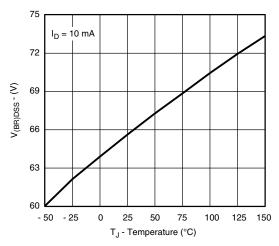
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**On-Resistance vs. Gate-to-Source Voltage** 



On-Resistance vs. Gate-to-Source Voltage



Drain-Source Breakdown Voltage vs. Junction Temperature

0.0001

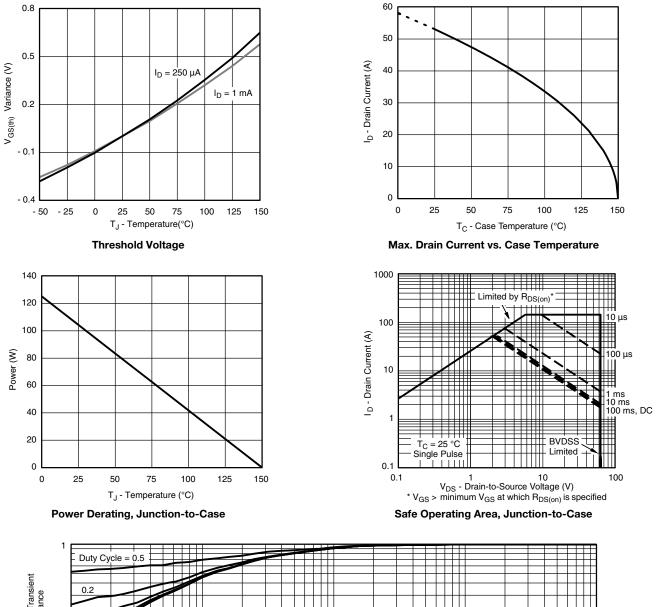
0.001

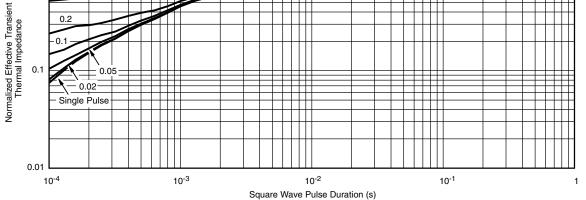
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





#### Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?68633">www.vishay.com/ppg?68633</a>.

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## **TO-220AB**



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
	0413-Rev. P,		0.102	0.118

Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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